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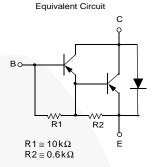
# TIP105 / TIP107 PNP Epitaxial Silicon Darlington Transistor

## **Features**

- Monolithic Construction with Built-in Base-Emitter Shunt Resistors
- High DC Current Gain:
   h<sub>FF</sub> = 1000 @ V<sub>CF</sub> = -4 V, I<sub>C</sub> = -3 A (Minimum)
- Collector-Emitter Sustaining Voltage
- Low Collector-Emitter Saturation Voltage
- Industrial Use
- Complementary to TIP102



1.Base 2.Collector 3.Emitter



## **Ordering Information**

Part Number	Top Mark	Package	Packing Method
TIP105	TIP105	TO-220 3L (Single Gauge)	Bulk
TIP105TU	TIP105	TO-220 3L (Single Gauge)	Rail
TIP107	TIP107	TO-220 3L (Single Gauge)	Bulk
TIP107TU	TIP107	TO-220 3L (Single Gauge)	Rail

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_C = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter		Value	Unit	
V <sub>CBO</sub>	Collector-Base Voltage	TIP105	-60	V	
		TIP107	-100	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	TIP105	-60	V	
		TIP107	-100	V	
V <sub>EBO</sub>	Emitter-Base Voltage		-5	V	
I <sub>C</sub>	Collector Current (DC)		-8	Α	
I <sub>CP</sub>	Collector Current (Pulse)		-15	Α	
I <sub>B</sub>	Base Current (DC)		-1	Α	
T <sub>J</sub>	Junction Temperature		150	°C	
T <sub>STG</sub>	Storage Temperature Range	-65 to 150	°C		

## **Thermal Characteristics**

Values are at  $T_C = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Unit
В	Collector Dissipation (T <sub>A</sub> = 25°C)	2 W	
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> = 25°C)	80	VV

## **Electrical Characteristics**(1)

Values are at  $T_C = 25$ °C unless otherwise noted.

Symbol	Parameter		Conditions	Min.	Max.	Unit
V <sub>CEO</sub> (sus)	Collector-Emitter Sustaining Voltage	TIP105	$I_{C} = -30 \text{ mA}, I_{B} = 0$	-60		V
		TIP107		-100		
I <sub>CEO</sub>	Collector Cut-Off Current	TIP105	$V_{CE} = -30 \text{ V}, I_{B} = 0$		-50	μА
		TIP107	$V_{CE} = -50 \text{ V}, I_{B} = 0$		-50	
I <sub>CBO</sub>	Collector Cut-Off Current	TIP105	$V_{CB} = -60 \text{ V}, I_{E} = 0$		-50	
		TIP107	$V_{CB} = -100 \text{ V}, I_{E} = 0$		-50	μΑ
I <sub>EBO</sub>	Emitter Cut-Off Current		$V_{EB} = -5 \text{ V}, I_{C} = 0$		-2	mA
h	DC Current Gain		$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	1000	20000	
h <sub>FE</sub>	DC Current Gain	Current Gain		200		
\/ (oot)	Collector-Emitter Saturation Voltage		$I_C = -3 \text{ A}, I_B = -6 \text{ mA}$		-2.0	V
V <sub>CE</sub> (sat)			$I_C = -8 \text{ A}, I_B = -80 \text{ mA}$		-2.5	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage		$V_{CE} = -4 \text{ V}, I_{C} = -8 \text{ A}$		-2.8	V
C <sub>ob</sub>	Output Capacitance		V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 0.1 MHz		300	pF

### Note:

1. Pulse test: pw  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.

## **Typical Performance Characteristics**

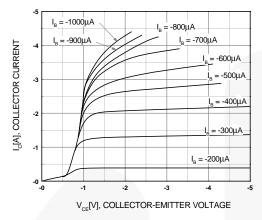


Figure 1. Static Characteristic

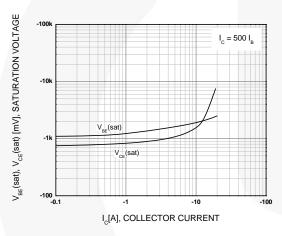


Figure 3. Collector-Emitter Saturation Voltage and Base-Emitter Saturation Voltage

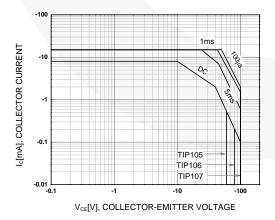


Figure 5. Safe Operating Area

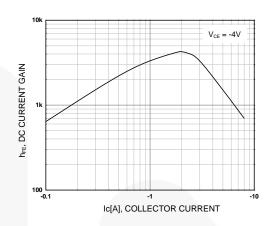


Figure 2. DC Current Gain

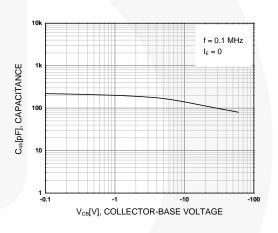


Figure 4. Collector Output Capacitance

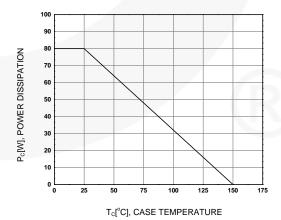
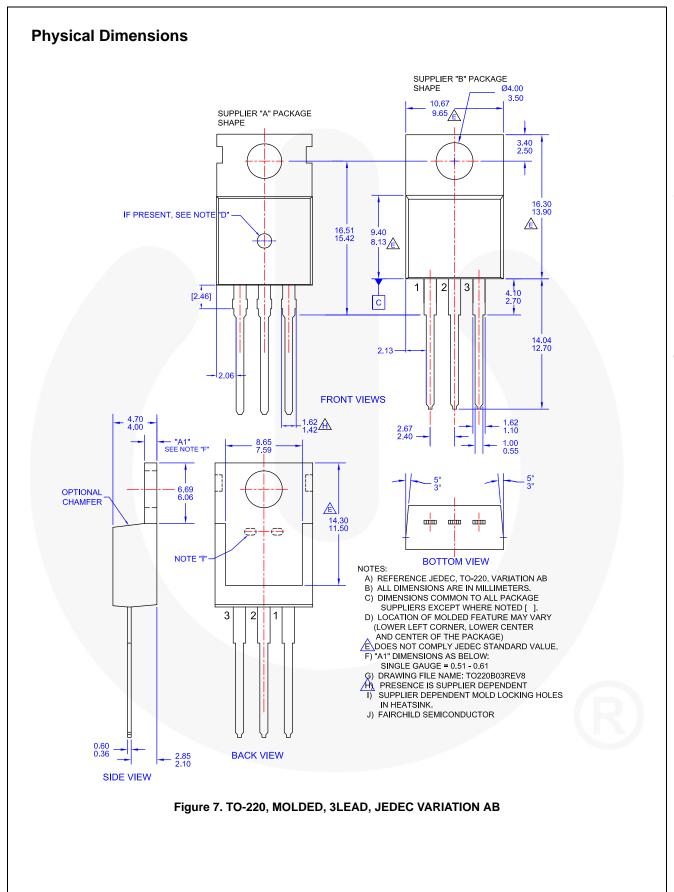


Figure 6. Power Derating







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